

SEATING PLANE

(L)

## DIP39, 54.50x31.00x5.60, 1.78P **CASE MODGC ISSUE B**

## **DATE 21 DEC 2023**

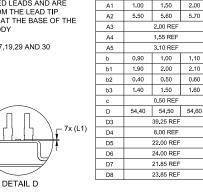
## NOTES:

(e6)

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS

DETAIL C

- DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP
- POSITION OF THE LEAD IS DETERMINED AT THE BASE OF THE LEAD WHERE IT EXITS THE PACKAGE BODY
- AREA FOR 2D BAR CODE SHORTENED/CUT PINS ARE 2,5,8,11,14,17,19,29 AND 30



DIM

Α

MILLIMETERS

12.7

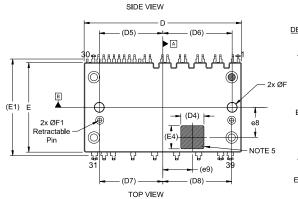
MAX.

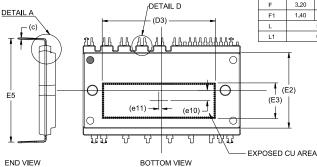
13.2

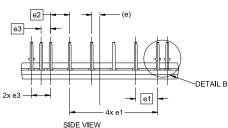
MIN. NOM.

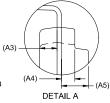
12.20

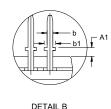
	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
Е	30.90	31.00	31.10
E1	33.50 REF		
E2	26.14 REF		
E3	12,35 REF		
E4	8.00 REF		
E5	35.40	35.90	36.40
е	2.81 REF		
e1	7.62 BSC		
e2	6.60 BSC		
e3	3.30 BSC		
e4	5,35 REF		
e5	6.10 BSC		
e6	8.02 REF		
e7	1.78 BSC		
e8	10.35 REF		
e9	10.25 REF		
e10	3.60 REF		
e11	1,00 REF		
e12	0.89 BSC		
F	3.20	3.30	3.40
F1	1.40	1.50	1.60
L	5.60 REF		
L1	0.10 REF		

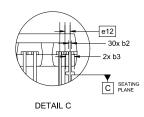












## **GENERIC MARKING DIAGRAM\***

XXXXXXXXXXXXXXXX ZZZATYWW 2D CODE

XXXXX = Specific Device Code

= Assembly Lot Code

= Assembly & Test Location

= Year ww = Work Week \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " • ", may or may not be present. Some products may not follow the Generic Marking.

	*****	y	<u>-                                      </u>	
DOCUMENT NUMBER:	98AON91300G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	DIP39, 54.50x31.00x5.60, 1	.78P	PAGE 1 OF 1	

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.